**EMB2 FHA** 

General purpose (Dual digital transistor)

**AEC-Q101 Qualified** 

DTr2

Parameter	DTr1 and DTr2	
V <sub>CC</sub>	-50V	
I <sub>C(MAX.)</sub>	-100mA	
R <sub>1</sub>	47kΩ	
R <sub>2</sub>	47kΩ	

Two DTA144E chips in a EMT6 package.
Mounting possible with EMT3 automatic

3)Transistor elements are independent,

4)Mounting cost and area can be cut in half.

# ● Outline SOT-563 SC-107C

### Inner circuit

EMT6

# (1) DTr1 GND(Emitter) (6) (5) (4) (3) DTr2 OUT(Collector) (4) DTr2 GND(Emitter) (5) DTr2 IN(Base) (6) DTr1 OUT(Collector) (1) (2) (3)

Features

mounting machines.

eliminating interference.

Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMB2 FHA	SOT-563 (EMT6)	1616	T2R	180	8	8000	B2

### ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Parameter	Symbol	Values	Unit
Supply voltage	V <sub>cc</sub>	-50	V
Input voltage	V <sub>IN</sub>	-40 to 10	V
Output current	Ι <sub>ο</sub>	-30	mA
Collector current	I <sub>C(MAX)</sub> *1	-100	mA
Power dissipation	P <sub>D</sub> <sup>*2*3</sup>	150	mW/TOTAL
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

### • Electrical characteristics (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Parameter	Symbol	Conditions	Values			Unit	
	Symbol Conditions		Min.	Тур.	Max.	Unit	
Inputivaltage	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA	-	-	-0.5	V	
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -2mA	-3.0	-	-		
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	-	-100	-300	mV	
Input current	I <sub>I</sub>	V <sub>1</sub> = -5V	-	-	-180	μA	
Output current	I <sub>O(off)</sub>	$V_{CC} = -50V, V_{I} = 0V$	-	-	-500	nA	
DC current gain	G	V <sub>O</sub> = -5V, I <sub>O</sub> = -5mA	68	-	-	-	
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ	
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-	
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz	

\*1 Characteristics of built-in transistor.

\*2 Each terminal mounted on a reference land.

\*3 120mW per element must not be exceeded.



### •Electrical characteristic curves (T<sub>a</sub> = 25°C) <For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)

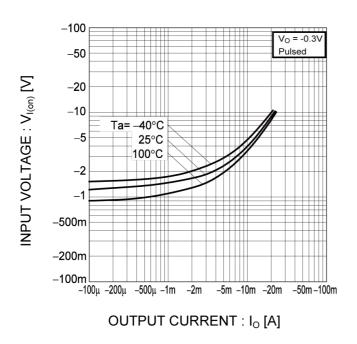


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

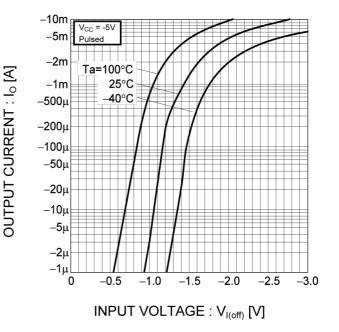


Fig.3 Output Current vs. Output Voltage

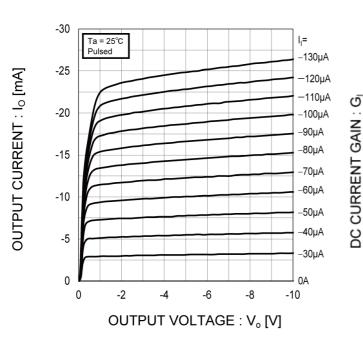
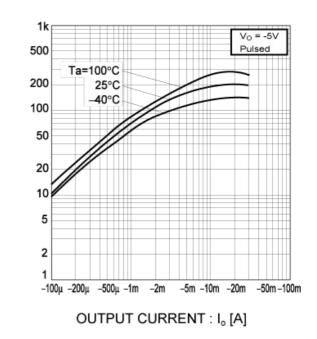


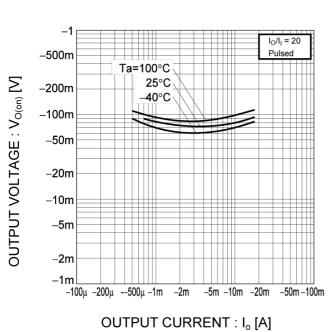
Fig.4 DC Current Gain vs. Output Current





## • Electrical characteristic curves ( $T_a = 25^{\circ}C$ )

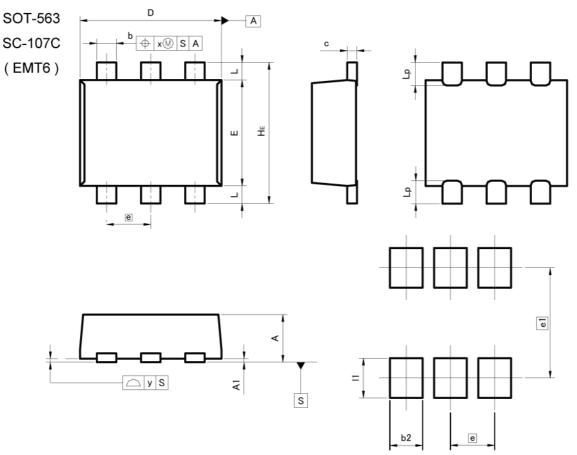
<For DTr1 and DTr2 in common>



### Fig.5 Output Voltage vs. Output Current



### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
A	0.45	0.55	0.018	0.022		
A1	0.00	0.10	0.000	0.004		
b	0.17	0.27	0.007	0.011		
с	0.08	0.18	0.003	0.007		
D	1.50	1.70	0.059	0.067		
E	1.10	1.30	0.043	0.051		
е	0.	50	0.020			
HE	1.50	1.70	0.059	0.067		
L	0.10	0.30	0.004	0.012		
Lp	-	0.35	-	0.014		
x	-	0.10	-	0.004		
У		0.10	-	0.004		
DIM	MILIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
b2	-	0.37	-	0.015		
e1	1.	25	0.049			
11	-	0.45	—	0.018		

Dimension in mm/inches



# Notice

### **Precaution on using ROHM Products**

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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CLASSⅣ	CLASSI	CLASSⅢ	CLASSII

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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